

Freescale Semiconductor

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Document can be found at http://freescale.com/rf/models Go to Models/Agilent EEsof ADS for Agilent's ADS v2003c, Release Notes and Installation Instructions

Agilent's Advanced Design System RF High Power Products Design Kit Release v2003cp0704

Release Notes and Installation Instructions





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I. INTRODUCTION

This current release of the RF High Power Products Design Kit for ADS v2003c has been implemented as follows:

- The Library is implemented as an Agilent® EEsof® EDA Advanced Design System (ADS) Design Kit and should be installed according to Agilent's instructions on installing Design Kits.
- There is now only one Zip file for all of the major platforms that Freescale Semiconductor supports (Microsoft Windows 2000, XP, Solaris 2.7/2.8/2.9 and HPUX 11.0/11.11). This is because ADS v2003c now allows the use of dynamically linked or shared-object libraries for distribution of user-compiled models. We are no longer required to provide a new simulator executable for each computing platform.
- The Design Kit was implemented per Agilent's instructions contained in the *Design Kit Development Manual* (dated December 2003). Therefore, the structure of our library has been modified per Agilent's requirements so that Agilent can help support installation and simulation issues in the future. Because of this modification, we must now use a new element called *TechInclude* (see "Release Notes, TechInclude Element" in this document). The TechInclude element is now required on all top-level schematics for simulation purposes.
- The Library has gone through several content changes:
 - New HV6 parts have been added.
 - The first RF IC component part has been introduced to the library.
 - New lower thermal resistance package "H" parts have been added.
 - New lead-free "N" parts have added.
 - The latest release is compatible with previous library releases.

The Freescale Semiconductor RF Modeling Team highly recommends that you read through this document thoroughly to enable a smooth installation and transition to the new release.



II. RELEASE NOTES

A. TechInclude Element

Because of the change from a totally customized library to an ADS Design Kit, a TechInclude element is now required. For this and future releases, you must insert the FSL_TECH_INCLUDE element at the top-level of all designs where simulation is performed. ADS only allows you to place one TechInclude element on any one design. If you do not place the TechInclude element at the top-level or if you place it within a subcircuit, a simulation error will occur. For example:

Error detected by HPEESOFSIM during netlist parsing `MRF1` is an instance of an undefined element ...

The FSL_TECH_INCLUDE element is now the sixth element in the Freescale Semiconductor RF High Power Model Library palette and looks like the following when placed in a schematic:



For more examples of using the TechInclude element, download the Customer Example Project from the Freescale Semiconductor RF High Power Model Libary website at http://www.freescale.com/rf/models. Go to Agilent EESOF's ADS. Right-click on the Agilent ADS v2003c Example Project hyperlink to download the example project.

B. Parts Added to the (v2003cp0704) Library

The following tables contain the new parts that were added to the RF High Power Products Design Kit v2003cp0704 release.

1. LDMOS Discrete Parts

MRF377	MRF5S9101	MRF6S19100H
MRF9200	MRF9030	MRF6S21100H
MRF9210	MRF9030S	MRF6P21190H
MRF5S9070N	MRF9030M	
MRF5S9100	MRF9030MB	

2. RF IC Components

MW4IC2230



C. Cancelled Parts

MET Models	Root Models
MRF182, MRF182S	MRF182, MRF182S
MRF183, MRF183S	MRF183, MRF183S
MRF185	MRF184, MRF184S
MRF9180S	MRF185, MRF186
MRF18090AS	MRF187, MRF187S
MRF19120S	MRF286, MRF286S
MRF19125S	MRF9180S
MRF21120S	MRF18090AS
MRF21180S	MRF19120S
	MRF19125S
	MRF21120S
	MRF21180S
	MRF6522_10R1
	MRF6522_5R1
	MRF6525_10R1
	MRF6525_5R1

The following parts have been labeled as cancelled:

If any of these part names are referenced in existing designs and need to be used, you will need to replace FSL_MRF_MET_MODEL/FSL_MRF_ROOT_MODEL elements with FSL_MRF_MET_CANCELLED_MODEL/FSL_MRF_ROOT_CANCELLED_MODEL elements, along with the FSL_MRF_MET_PP_MODEL/FSL_MRF_ROOT_PP_MODEL elements with FSL_MRF_MET_PP_CANCELLED_MODEL/FSL_MRF_ROOT_PP_CANCELLED_MODEL. The "Cancelled" version of these parts can *only* be found in the Component Library Browser under the Library heading, Freescale RF High Power Model Library.

/ 🖆 🔚 📥 🔟 🖆) 💼 🙍 🕂 = + - 🍳					
raries	Components		1.2			_
NEC (No Layout)	Component	Description	Lib-name	lacement Stat		
	FSL_MRF_MET_MODEL	FSL_MRF_MET_MODEL	Freescale RF High Power Model Library			N/
- Siemens (No Layout)	FSL_MRF_MET_PP_MODEL	FSL_MRF_MET_PP_MODEL	Freescale RF High Power Model Library			N/
Sony (No Layout)	FSL_MRF_ROOT_MODEL	FSL_MRF_ROOT_MODEL	Freescale RF High Power Model Library	NOLAYOUT	N/A	N/
Toshiba (No Layout)	FSL_MRF_ROOT_PP_MODEL	FSL_MRF_ROOT_PP_MODEL	Freescale RF High Power Model Library	NOLAYOUT	N/A	N/
⊡- System Library Mixers	FSL_TECH_INCLUDE	Freescale LDMOS Technology Include	Freescale RF High Power Model Library	NOLAYOUT	N/A	N/
Mixers Amplifiers	FSL MRF MET CANCELLED MODEL	FSL MRF MET MODEL CANCELLED PART	Freescale RF High Power Model Library	NOLAYOUT	N/A	N/
- SMT Mixers	FSL MRF ROOT CANCELLED MODEL	FSL MRF ROOT MODEL CANCELLED PART	Freescale RF High Power Model Library		N/A	NZ
SMT Amplifiers	FSL MRF MET PP CANCELLED MODEL	FSL MRF MET PP MODEL CANCELLED PART	Freescale RF High Power Model Library			NZ
- SMT Filter						NZ
Filters	FSL_MRF_RUUT_PP_CANCELLED_MODEL	FSL_MRF_ROOT_PP_MODEL CANCELLED PART	Freescale RF High Power Model Library	NULAYUUT	N/A	NZ.
Power Dividers Switches						
- Freescale HVICp Design Kit						
- Freescale RF High Power Mode						
- Block Text Fonts						
IDF Components						
Motorola LDMOS Model Library						



D. Forward Migration of the RF LDMOS Model Library Components

Previous versions of the RF LDMOS Model libraries can co-exist with the new v2003cp0704 version of the RF LDMOS Model library. The v2003cp0704 library has its own unique TechInclude along with its own MET and ROOT model components. It is this uniqueness that allows the libraries to co-exist and permit a seamless integration of new parts into an existing design or project. Be sure to read the warning below before proceeding into the migration process.

If you have designs in ADS projects using a previous release of the RF LDMOS model library, DO NOT remove the TechInclude which was created with the previous library. The RF Modeling Team RECOMMENDS: create a copy of your existing ADS project BEFORE migrating or adding the new library components to the project. Always keep the previous library release available for backward compatibility until all components have been migrated.

ADS projects will need to have the previous release RF LDMOS Model library TechInclude element as well as the new FSL_TECH_INCLUDE TechInclude element for simulations to run properly. The new library components will be able to reside in an ADS project created with the previous library release and allow migrating new components into existing designs. New projects will require the new TechInclude element at the top-level of each design.

1. Integrating v2003cp0704 Parts into an existing ADS design (Migration Plan)

- a) Verify the previous version of the RF LDMOS Model library is currently enabled.
- b) Install v2003cp0704 RF High Power Model library following the steps in Section III.
- c) Open an existing ADS Project.
- d) Place the FSL_TECH_INCLUDE component at the top-level of the design. *Note:* There should now be two TechInclude components in the design.
- e) Go to Step g for placing new components; otherwise, continue to Step f.
- f) Delete an existing component (if replacement with a new component is desired).
- g) Select the desired MET or ROOT component from the ADS device palette.
- h) Place the component.
- i) Select Model Name from the form pulldown menu (Parameter Entry Mode).
- j) Save the design.

2. Creating a new project (Non-Migration)

- a) Disable or remove the previous RF LDMOS Model library, see Section IV for details.
- b) Install v2003cp0704 RF LDMOS Model library following the steps in Section III.
- c) Select New Project.
- d) Place the FSL_TECH_INCLUDE component at the top-level of the design.
- e) Select the desired MET or ROOT component from the ADS device palette.
- f) Place the component.
- g) Select Model Name from the form pulldown menu (Parameter Entry Mode).
- h) Save the design.



III. DESIGN KIT INSTALLATION (v2003cp0704)

A. Download Design Kit

This section outlines the procedures necessary to install the new RF High Power Products Design Kit (v2003cp0704) into ADS v2003c.

Before you can install the Design Kit, you must first go to the Freescale Semiconductor RF High Power Model website at http://freescale.com/rf/models. Click Agilent's ADS v2003c Library Release Notes and Installation Instructions, and download the

ADS_FSL_LIBRARY_v2003cp0704.zip file by right-clicking on the file link and performing a Save Link/Target As to save the file to your desktop.

Next, follow the steps below to install the Library and verify your successful installation. If you are having problems with the installation, you can view the *Design Kit Installation and Setup Manual* (dated December 2003) for ADS v2003c in the ADS v2003c documentation (specifically, page 2-5). To install the Library successfully, go to the "Support" section of this document for information on how to get support from the Freescale Semiconductor RF Modeling Team or from Agilent.

The following steps assume you currently have ADS v2003c correctly installed and that you have root or administrative access to your ADS installation. If the previous library is installed, please read Section II, Release Notes, Part D, then refer to Section IV, Removing Design Kits in the ADSv2003c before continuing to Step B, Install Design Kit.

B. Install Design Kit

1. Choose DesignKit > Install Design Kit from the ADS Main Window.

The following dialog box will appear:

Install AD5 Design Kit	×
- 1. Unzip Design Kit-	
This step may be skipped if the Design Kit is already unzippe	d.
Unzip Design Kit Now	
2. Define Design Kit	
Enter full Path to the directory of the desired Design Kit. If available, the remaining info will be automatically filled in.	
Path	
	Browse
Name	
1	
Boot File (optional)	
	Browse
Version	
Warning: Design Kit warnings and information.	
3. Install Design Kit	
Select Installation Level : USER LEVEL	_
OK Cancel	Help



2. UnZip the Downloaded ADS Design Kit Zip File.

Click the Unzip Design Kit Now button. The following dialog box will appear:

Unzip ADS	Design Kit	<
Unzip File:	C:\ADS2003C\ADS_FSL_LIBRARY_v2003cp0704.zip Browse	
To Directory:	C:\ADS2003C\custom Browse	
01	Cancel Help	-

Enter the path to the Zip file. Enter the path for the **To Directory** field where you want the Design Kit to be located. Use the **Browse** buttons to help you locate the Zip file and To Directory locations. In the preceding example, the default ADS Custom directory was selected for a Site-Wide installation. (This path is highly suggested, but optional.)

Click **OK.** A new directory called ADS_FSL_LIBRARY will appear within the directory path that you specified in the **To Directory** field. Within this new directory, you should see the following subdirectories:

- circuit
- de
- design kit
- doc
- examples
- bin



3. Define the Design Kit.

When the Unzip procedure is complete, the following Install ADS Design Kit dialog box will reappear with default values specified for Path, Name, Boot File and Version:

Install AD5 Design Kit	×
1. Unzip Design Kit	
This step may be skipped if the Design Kit is already unzipped.	
(Unzip Design Kit Now)	
_ 2. Define Design Kit	
Enter full Path to the directory of the desired Design Kit. If available, the remaining info will be automatically filled in.	
Path	
\$HPEESOF_DIR/custom/ADS_FSL_LIBRARY/ Browse.	
Name	-
ADS_FSL_LIBRARY	
Boot File (optional) de/ael/boot Browse	_
Ide/ael/boot Browse.	<u> </u>
Version	
v2003cp0704	
Warning: Design Kit warnings and information.	
3. Install Design Kit	
Select Installation Level : USER LEVEL	⊒∥
JOSEN LEVEL	
OK Cancel Help	

It is not necessary for you to manipulate any of the default values unless you want to perform some extra customization.

Note: Extra customization is not recommended.

4. Install the Design Kit.

You will need to make a choice within the **Select Installation Level** field. In the example above, the Site Level or Site-Wide installation was selected because the Design Kit was Unzipped and installed in the ADS Custom directory. You can select "SITE LEVEL," "USER LEVEL," "STARTUP LEVEL" or "PROJECT LEVEL." Review the *Design Kit Installation and Setup Manual* (page 2-14) and decide how the Design Kit will be used. We suggest that it be placed as a SITE LEVEL installation. After you make your selection, click **OK**.



If the installation was successful, the following dialog box will appear:



C. Verify Your Design Kit Installation

To verify your Design Kit Installation, choose **DesignKit > Setup Design Kits** from the main window. The following dialog box will appear:

Setup ADS Design Kits	x
View/Modify the default loading status of Levels and Design K PLEASE NOTE: Some changes will be effective only after AD	
Overview B SITE LEVEL OUSER LEVEL STARTUP LEVEL PROJECT LEVEL	View/Modify Properties Level Information [SITE "ads.lib" File [\$HPEESOF_DIR/custom/design_kit/ads.lib/ [Info: "ads.lib" loaded at ADS startup.
	Design Kit Information Update Design Kit properties as needed. Path \$HPEESOF_DIR/custom/ADS_FSL_LIBRARY/ Browse
	Name ADS_FSL_LIBRARY Boot File (optional) de/ael/boot Version
Disable Design Kit Cut Copy Paste * Settings not yet applied (ADS may need to be re-started for settings to take effect)	v2003cp0704 Info: Design Kit enabled - Level enabled. Update Properties Add Design Kit to Level
OK Apply Rese	et Print Cancel Help

Click on **ADS_FSL_LIBRARY Design Kit** (it will be a subentry of the level where it was installed) to verify the installation paths, names, version, etc.



WARNING: Typically, the SITE LEVEL is disabled (yellow button beside SITE LEVEL). If you installed the Design Kit at the SITE LEVEL, you must enable the SITE LEVEL by clicking **SITE LEVEL** and choosing **Enable Level**. Click **OK** to enable Design Kits within this level.

D. List Design Kits in Use and Enabled at Each Level

Choose **DesignKit > List Design Kits** ... to view these Design Kits. The following dialog box appears:

	List ADS Design Kits	ī					[×
Γ	Currently installed Desi	gn Kits						1
	🔽 View details							
	Name	Version	Status	Path	Boot File	Load Level		
	ADS_FSL_LIBRARY	v2003cp0704	enabled	\$HPEESOF_DIR/custom/ADS_FSL_LIBRARY/	de/ael/boot	SITE	\$HPEESOF_DIR/custom.	
	▲ Ena	ble Selected Des	ign Kit	Save to File		1	▶ Print	
		ОК		Cancel		Н	elp	

IV. REMOVING DESIGN KITS IN ADS V2003C

Agilent has not provided a path for users who have installed Design Kits to remove them when needed. So, the removal of the design kits is a manual process. However, you can disable a Design Kit by selecting the **Setup Design Kits... Menu** choice from the Design Kit menu in the main ADS window.

Ē	Advanc	ed Desig	n System	n (Main)				×
File	e View	Options	Window	DesignKit	DesignGuide	Help		
	56	2	€ [Install Design Kits Setup Design Kits List Design Kits				
E	ile Brows	er						
		 3 artwork_	MotIntADS Lib	Setup Project			Double click to open	
JUse	•							/1.



When the Setup Design Kits dialog box appears, as below, select the Design Kit to Disable and click **Disable Design Kit**.

Setup AD5 Design Kits	×
View/Modify the default loading status of Levels and Design Ki PLEASE NOTE: Some changes will be effective only after ADS	
	View/Modify Properties
	Level Information
ADS_MOT_LIBRARY	
USER LEVEL	Level
STARTUP LEVEL PROJECT LEVEL	SITE
	"ads.lib" File
	\$HPEESOF_DIR/custom/design_kit/ads.lib/
	Info: "ads.lib" loaded at ADS startup.
	Design Kit Information
	Update Design Kit properties as needed.
	opuale Design Nic properties as needed.
	\$HPEESOF_DIR/custom/ADS_MOT_LIBRARY/ Browse
	Name
	ADS_MOT_LIBRARY
	Boot File (optional)
	de/ael/boot Browse
Disable Design Kit Cut Copy Paste	Version
Default Design Kit for new projects	v2003ap1003
* Settings not yet applied	Info: Design Kit enabled - Level enabled.
(ADS may need to be re-started for settings to take effect)	
	Update Properties Add Design Kit to Level
OK Apply Reset	Print Cancel Help



The Design Kit will appear in the dialog box, like the ADS_MOT_LIBRARY in following example:

Setup AD5 Design Kits
View/Modify the default loading status of Levels and Design Kits. PLEASE NOTE: Some changes will be effective only after ADS is re-started. Overview • SITE LEVEL • ADS_MOT_LIBRARY'* • USER LEVEL • STARTUP LEVEL • PROJECT LEVEL • Design Kit Information Update Design Kit Information
Default Design Kit for new projects Info: Design Kit disabled - Level enabled.
OK Apply Reset Print Cancel Help

Note: You must then select Apply or OK and then restart ADS for the changes to take effect.



You can then verify the disabled Design Kit, by selecting the List Design Kits... Menu choice from the Design Kit menu in the main window as shown below:

	List ADS Design Kits						×
Г	- Currently installed Design Kit	s					
	🔽 View details						
	Name	Version	Status	Path	Boot File	Load Level	
	ADS_MOT_LIBRARY	v2003ap1003	disabled	\$HPEESOF_DIR/custom/ADS_M(de/ael/boot	SITE	\$HF
	_						
	•						►
	Enable Cales	ted Design Kit		Save to File		Print	
	Enable Select	ea Design Nit		Save to File			
	OK			Cancel	Help	2	

The directory for the Design Kit still exists even though it is disabled. ADS v2003c *will not* let the user unZip a new Design Kit over the old one with the same name when going through the install procedure. *The user must manually delete the directory tree of the DesignKit before installation can begin on an update.* For example, the owner of the ADS v2003c installation directory would have to go to the ADS custom directory and delete the disabled Design Kit directory tree DesignKitName/ in a command window or file manager program.

After deleting the Design Kit directory tree and restarting ADS, the Setup Design Kits dialog box will appear with a *red bullet* and *red text* because the path no longer exists, as shown on the next page:



📕 Setup ADS I	Design	Kits
---------------	--------	------

View/Modify the default loading status of Levels and Design Kits. PLEASE NOTE: Some changes will be effective only after ADS is re-started.

Overview	View/Modify Properties
₽ ● SITE LEVEL	Level Information
ADS_MOT_LIBRARY USER LEVEL STARTUP LEVEL PROJECT LEVEL	Level SITE "ads.lib" File \$HPEESOF_DIR/custom/design_kit/ads.lib/ Info: "ads.lib" loaded at ADS startup.
	Design Kit Information Update Design Kit properties as needed.
	Path SHPEESOF_DIR/custom/ADS_MOT_LIBRARY/ Browse Name ADS_MOT_LIBRARY
	Boot File (optional)
Enable Design Kit Cut Copy Paste	Version v2003ap1003
Default Design Kit for new projects	Info: Design Kit disabled - Level enabled.
* Settings not yet applied (ADS may need to be re-started for settings to take effect)	Warning: Incorrect Path and Boot File.
	Update Properties Add Design Kit to Level
OK Apply Reset	Print Cancel Help

You can then select the Design Kit, click **Cut** to remove the kit completely and then click OK to activate the changes. After restarting ADS v2003c again, the disabled/deleted Design Kit will no longer appear in the List of Design Kits window.

This tedious procedure will probably be changed in future releases of ADS.

X



V. CUSTOMER PROJECT INSTALLATION

The custom project can be installed on all major platforms that support Microsoft Windows(Win32), Sun Microsystems(Solaris), and Hewlett-Packard(HPUX) environments.

A. ADS v2003c Users: Installing the customer_ads_prj directory

Before you can install the Customer Example project directory, you must first go to the Freescale Semiconductor RF LDMOS website (http://freescale.com/rf/models). Go to Agilent EESOF's ADS. Right-click on the Agilent ADS v2003c Example Project hyperlink to download the customer_ads_v2003cp0704_prj.Zip file. Select Save Link/Target As to save the file to your desktop.

1. ADS v2003c Unix Users

- a) Download the customer ads v2003cp0704 prj.zip file.
- b) UnZip the downloaded file by using ADS's Unzip utility found in the bin directory of the ADS installation directory. For example, from a Unix csh shell command prompt:

customer_ads.zap

c) Open ADS. From the File menu, select **Unarchive Project...** to unzap the directory.

Unarchive Project					
Unarchive File:	ing/customer_ads.zapį́	Browse	Working Directory	Startup Directory	
To Directory:	To Directory: /home/hpeesof		Working Directory	Startup Directory	
🗷 Open Project After Unarchive					
OK		Cancel		Help	



d) The new project directory is called customer_ads_prj.

The directory is just like any other ADS project directory and is ready to use. Choose **Open Project** from the File directory to open this project.

2. ADS v2003c PC Users

- a) Download the customer_ads_v2003cp0704_prj.zip file.
- b) UnZip the downloaded file by using ADS's Unzip utility found in the bin directory of the ADS installation directory. For example, from a DOS prompt:

```
set HPEESOF_DIR=C:\ads2003c
%HPEESOF_DIR%\bin\unzip customer_ads_v2003cp0704_prj.zip
Archive: customer_ads_v2003cp0704_prj.zip
inflating: customer_ads.zap
```

The result is an ADS zap archive file called customer_ads.zap.

c) Open ADS v2003c. From the File menu, select **Unarchive Project...** to unzap the directory.

🔲 Unarchive Pi	roject			×
Unarchive File:	D:\2003C\customer_ads.a	zap Browse	Working Directory	Startup Directory
To Directory:	D:\hpeesof\	Browse	Working Directory	Startup Directory
🔽 Open Project	After Unarchive			
	К	Cancel		Help

d) The new project directory is called customer_ads_prj.

The directory is just like any other ADS project directory and is ready to use. Choose **Open Project** from the File directory to open this project.

B. Using the customer_ads_prj Project Directory

The following instructions assume that you are using ADS v2003c for Unix or PC and currently have the customer_ads_prj project already open. A schematic file called Base_Model.dsn is used as device under test (DUT), within all of the example test schematics (at the lowest subcircuit level, see Figure 1) except for the Main_Transient, Main_1HB_Loadpull and Main_2HB_Loadpull designs. Therefore, it is easy to replace the current product model by editing the FET element and selecting a new model from the list. You can also replace the MET LDMOS model with a Root LDMOS model from the Freescale RF High Power Model Library palette and select the appropriate model from the list given.



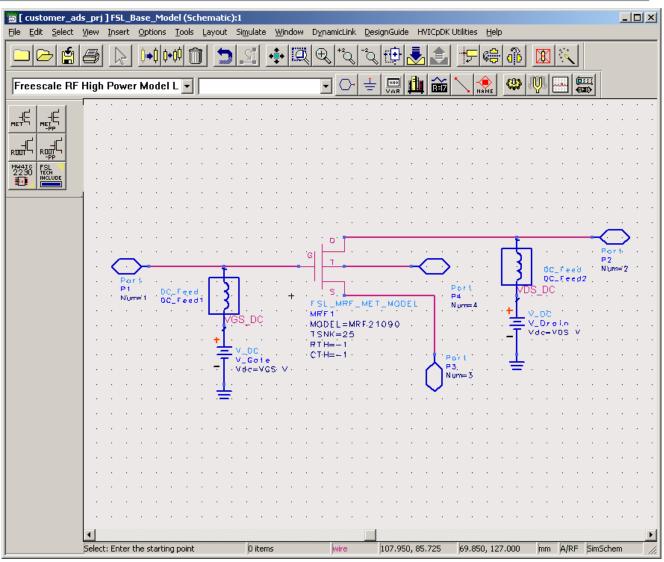


Figure 1. Schematic of FSL Base Model.dsn

Notice that Base_Model has as its parameters TSNK, RTH, CTH, VDS and VGS. Therefore, any test circuit that uses Base_Model as its DUT is able to pass thermal parameters to the MET LDMOS model as well as bias information.

Note: Keep these parameters in mind when replacing the given MET LDMOS model with another MET or Root LDMOS model. Setting TSNK, RTH and CTH to a value of -1 tells the simulator to use the default value of the model.

1. Selecting a New MET LDMOS Product Model.

A Library and Palette Group — the Freescale RF High Power Model Library — has been created with all of the current product models. Select a model type by clicking the **Component Library** icon and then clicking **Freescale RF High Power Model Library**.



There are four model types:

- FSL MRF MET MODEL—MET LDMOS Model
- FSL_MRF_MET_PP_MODEL—MET LDMOS Push-Pull Model
- FSL MRF ROOT MODEL—Root LDMOS Model
- FSL_MRF_ROOT_PP_MODEL—Root LDMOS Push-Pull Model

Figure 2 illustrates how to edit the current FSL_MRF_MET_MODEL and select a new product model to simulate inside the Base_Model design.

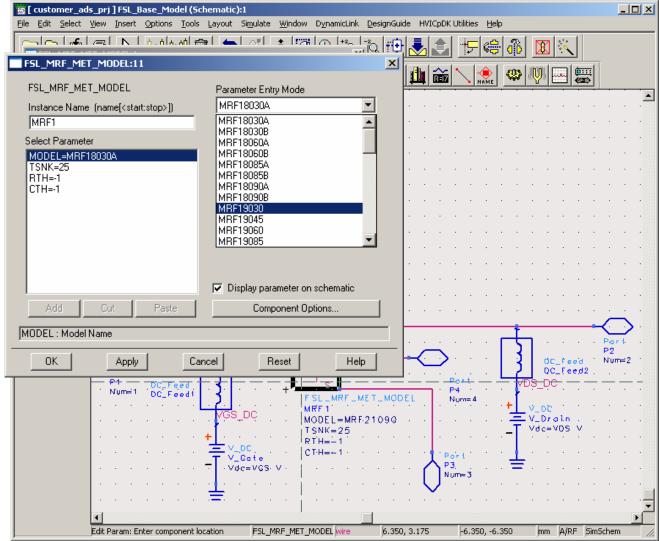


Figure 2. Selecting a New MET LDMOS Product Model

2. Selecting a Root Product Model.

The preceding procedure can also be used to select a Root LDMOS model from the palette or library group and replace the present FSL_MRF_MET_MODEL element. Because the Root model has no temperature component, the Fourth Node of Base_Model remains unconnected. However, this is not a problem when simulating. The parameters of Base_Model, TSNK, RTH and CTH do not affect the circuit when the Root LDMOS model is used.



Figure 3 shows how to replace the FSL_MRF_MET_MODEL with a new FSL_MRF_ROOT_MODEL and how to edit and select a new product model from the list given.

[customer_ads_prj] FSL_Base_Model File Edit Select View Insert Options Ti	l * (Schematic):1 ools Layout Si <u>m</u> ulate <u>Wi</u> ndow DynamicLii	nk DesignGuide HVICpDK Utilities Help	<u>_ </u>
FSL_MRF_ROOT_MODEL:1			Ī
FSL_MRF_ROOT_MODEL	Parameter Entry Mode		· · · · · ·
Instance Name (name[<start:stop>])</start:stop>	MRF19030		
MBF1	MRF18030A]	
Select Parameter	MRF18030B MRF18060A		
MODEL=MRF19030	MRF18060B MRF18085A		
	MRF18085B		
	MRF18090A MRF18090B		
	MRF19030 MRF19045		
	MRF19060		
	MRF19085	1	
	Display parameter on schematic		
Add Cut Paste	Component Options	1	
		<u></u>	
MODEL : Model Name			
OK Apply (Cancel Reset Help	<u> </u>	Port
		dc_feed	P2 Num≓2
	<u>╶╴┲╾╋╍</u> ┓╌╸╶╸╶╉╎┷┝╾╌╉╌		
P1 DC_Fee Num=1 DC_Fee			
	MRE 1	LROOT_MODEL Num=4	
	MODEL=M	RF-18030A · · · · · · · · · · · · · · · · · · ·	
	la 🕂 a la la la la la la la	······································	
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Figure 3. Selecting and Editing Choice of the FSL_MRF_ROOT_MODEL

3. Simulating Product Models Correctly.

As stated previously, the Base_Model.dsn schematic is the DUT for all of the example test schematic designs except for the Main_Transient, Main_1HB_Loadpull and Main_2HB_Loadpull designs. By following the preceding procedure for selecting the desired product model, each example test circuit is ready to simulate. Before performing a simulation, however, be sure to adjust the frequency, bias and power stimulus controls for your desired test setup. The VAR block in each test bench may also contain some variables that affect the test setup and may also need to be modified.

Note: The new FSL_TECH_INCLUDE element has to be placed at all top-level simulation schematics, which is now a requirement of the new Design Kit structure.



VI. TROUBLESHOOTING ADS INSTALLATION PROBLEMS

Please verify that the LDMOS Model Design Kit Library was installed correctly by going through the installation procedures outlined in this document before trying to troubleshoot problems.

Following is table of common problems and solutions to help you complete your installation if you are having problems.

Problem	Possible Solution
Under Unix, when starting ADS following the installation, the messages Loading Freescale Semiconductor's ADSv2003cp0704 RF High Power Model Library Freescale Semiconductor's ADSv2003cp0704 RF High Power Model Library Load Complete! do not appear upon startup. Under PC or Unix, after ADS is open, the Freescale RF High Power Model Library does not appear in the schematic palette or within the Component Library Browser window. Under PC or Unix, the Freescale RF High Power Model Library palette exists within the schematic window. However, when picking and placing an element, I get several message windows saying that the component symbol is not found.	 Check that the ADS_FSL_LIBRARY directory and all of its subdirectories are present in the ADS Custom directory. Verify that you are running ADS v2003c. Verify that the design_kit directory exists within the Custom directory and that the ads.lib file exists and is similar to the file shown in the footnote below.
Under PC or Unix, the Freescale RF High Power Model Library palette exists within the schematic window, and I can pick and place model parts to the schematic. However, when I try to simulate, I get the following simulation error messages within the simulator window: Warning detected by HPEESOFSIM during netlist parsing. Error detected by HPEESOFSIM during netlist parsing ëMRF11 is an instance of an undefined model ö' Under PC or Unix, the Freescale RF High Power Model Library palette exists within the schematic window, and I can pick and place model parts to the schematic. However, when I try to simulate, a window pops up indicating OPEN_SIMULATOR ERROR.	 Verify that the FSL_TECH_INCLUDE element exists in your top-level circuit that you are trying to simulate. Check that the ADS_FSL_LIBRARY directory and all of its subdirectories are present in the ADS Custom directory. Verify that you are running ADS v2003c. Verify that the design_kit directory exists within the Custom directory and that the ads.lib file exists and is similar to the file shown in the footnote below. If ADS 2003c was installed after the Freescale RF High Power Model Library was installed, the Freescale RF High Power Model Library must be re-installed.
Under PC or Unix, I have done everything above, and nothing seems to have an effect. The Freescale Semiconductor RF High Power Model Library does not load at all or partially loads with errors.	 Verify that all references to the <i>ADS_FSL_LIBRARY</i> environmental variable have been removed from your ADS startup wrapper script. If all else fails, see the "Support" section in this document about starting a Customer Service Request or contacting Agilent.

* Example ads.lib file contained within the ADS v2003c custom/design_kit directory:

ADS_FSL_LIBRARY | \$HPEESOF_DIR/custom/ADS_FSL_LIBRARY | de/ael/boot.atf | v2003cp0704



VII. KNOWN PROBLEMS

The following are known problems associated with the MET LDMOS model. This section will be updated regularly, as new problems are discovered and resolved. If you find a problem with the MET LDMOS, do not hesitate to let the Freescale Semiconductor RF Modeling Team know. We will do our best to solve all problems or supply workarounds in a timely manner.

ADS v2003c

- 1. The model may experience some convergence problems under two-tone conditions for some specific values of IF (f2-f1) impedance terminations. Problems have been experienced when the IF termination is close to an open (high impedance) condition.
- 2. Even though all of the different simulation types have been coded in the senior modules (linear, nonlinear, AC, noise and transient), the noise section of the code has not been tested.
- 3. Simulator convergence issues have been noticed by some customers using Harmonic Balance simulations (LSSP, HB1Tone, HB2Tone, etc.) with ideal 50 ohm terminations on the input and output. Because of the low input and output impedances of some devices, it is suggested that lower input and output impedance terminations, around 5 ohms, be used to eliminate convergence problems.

VIII. SUPPORT

If you have difficulties installing or using the RF High Power Products Design Kit, please feel free to contact the Freescale Semiconductor RF Modeling Team by selecting **RF LDMOS Model Help** from the Freescale Semiconductor RF High Power Models web page (http://freescale.com/rf/models). Follow the procedure for submitting a Customer Service Request. We will be glad to contact you and help you with your problems.

If you feel the problem is with your ADS v2003c installation, please contact Agilent EESof directly at 1-800-hpeesof (1-800-473-3763).



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